

MOS FIELD EFFECT TRANSISTOR 2SK3571

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The 2SK3571 is N-channel MOS FET device that features a low on-state resistance and excellent switching characteristics, designed for low voltage high current applications such as DC/DC converter with synchronous rectifier.

FEATURES

- •4.5V drive available.
- •Low on-state resistance,

 $R_{DS(on)1} = 9.0 \text{ m}\Omega \text{ MAX.} \text{ (Vgs} = 10 \text{ V, ID} = 24 \text{ A)}$

•Low gate charge

QG = 21 nC TYP. (VDD = 16 V, VGS = 10 V, ID = 48 A)

- •Built-in gate protection diode
- •Surface mount device available

★ ORDERING INFORMATION

PART NUMBER	PACKAGE		
2SK3571	TO-220AB		
2SK3571-S	TO-262		
2SK3571-ZK	TO-263		
2SK3571-Z	TO-220SMD Note		

Note TO-220SMD package is produced only in Japan.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vos = 0 V)	VDSS	20	V
Gate to Source Voltage (Vps = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	I _{D(DC)}	±48	Α
Drain Current (pulse) Note	ID(pulse)	±192	Α
Total Power Dissipation (T _A = 25°C)	P _{T1}	1.5	W
Total Power Dissipation (Tc = 25°C)	P _{T2}	40	W
Channel Temperature	T_ch	150	°C
Storage Temperature	Tstg	-55 to +150	°C

Note PW \leq 10 μ s, Duty Cycle \leq 1%

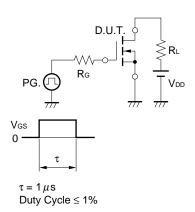
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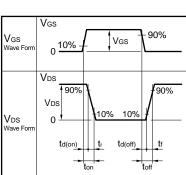


ELECTRICAL CHARACTERISTICS (TA = 25°C)

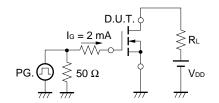
Characteristics	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Zero Gate Voltage Drain Current	Ipss	Vps = 20 V, Vgs = 0 V			10	μΑ
Gate Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5		2.5	V
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 24 A	11			S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, ID = 24 A		7.0	9.0	mΩ
	RDS(on)2	Vgs = 4.5 V, ID = 18 A		10	16	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		1100		pF
Output Capacitance	Coss	Vgs = 0 V		450		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		160		pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = 10 V, I _D = 24 A		13		ns
Rise Time	tr	Vgs = 10 V		5		ns
Turn-off Delay Time	td(off)	$R_G = 10 \Omega$		40		ns
Fall Time	t f			9		ns
Total Gate Charge	Q _G	V _{DD} = 16 V		21		nC
Gate to Source Charge	Qgs	Vgs = 10 V		4.2		nC
Gate to Drain Charge	Q _{GD}	ID = 48 A		5		nC
Body Diode Forward Voltage	V _{F(S-D)}	IF = 48 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 48 A, VGS = 0 V		41		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		27		nC

★ TEST CIRCUIT 1 SWITCHING TIME

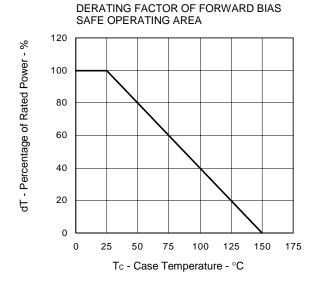


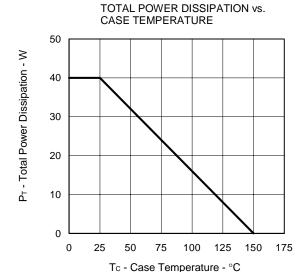


TEST CIRCUIT 2 GATE CHARGE

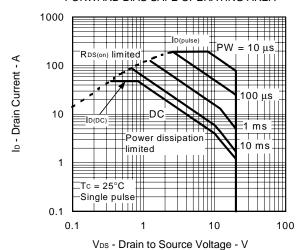


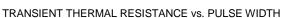
★ TYPICAL CHARACTERISTICS (TA = 25°C)

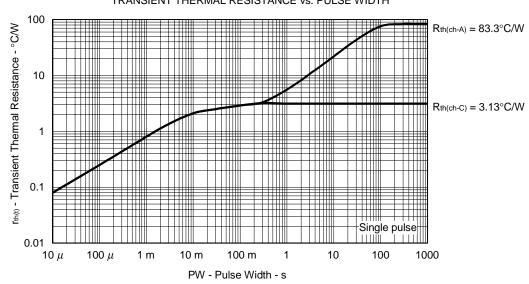




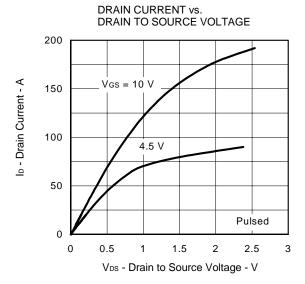
FORWARD BIAS SAFE OPERATING AREA

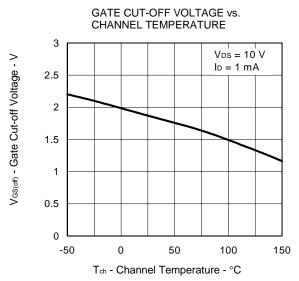


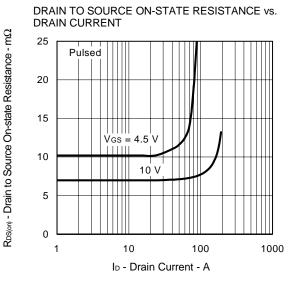




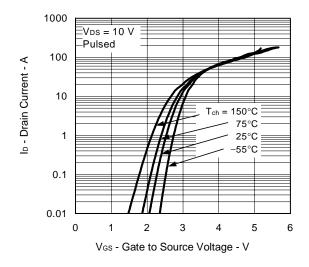
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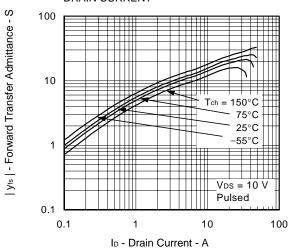




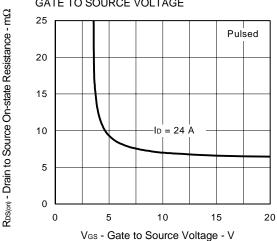
FORWARD TRANSFER CHARACTERISTICS

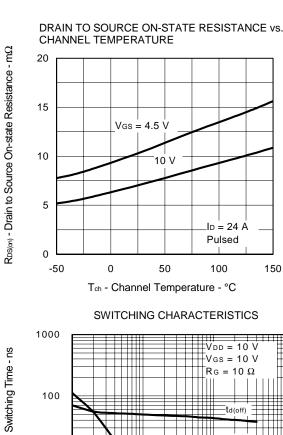


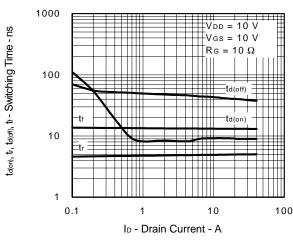
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

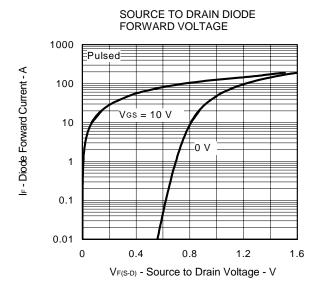


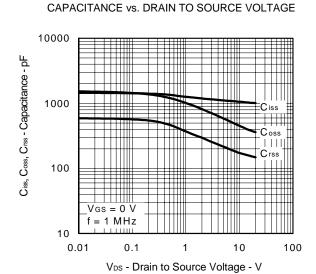
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

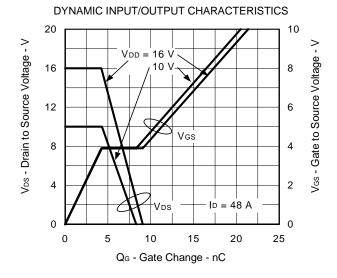


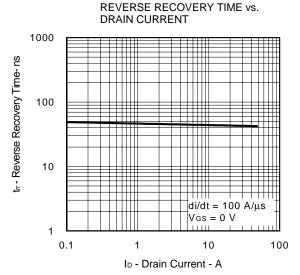






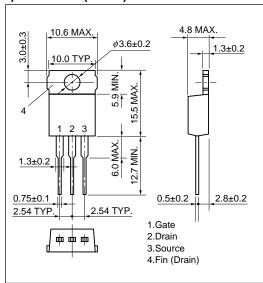




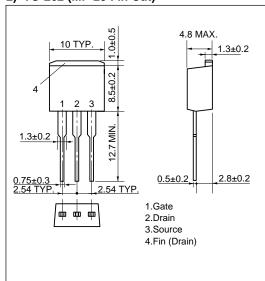


★ PACKAGE DRAWINGS (Unit: mm)

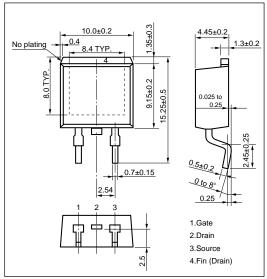
1) TO-220AB (MP-25)



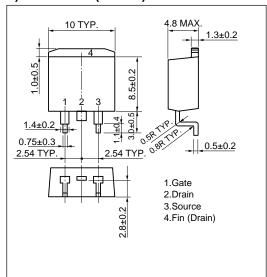
2) TO-262 (MP-25 Fin Cut)



3) TO-263 (MP-25ZK)

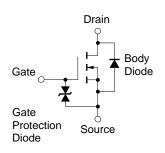


4) TO-220SMD (MP-25Z)



Note This package is produced only in Japan.

EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

[MEMO]

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